

ASSEMBLY NOTES:

Assembly shall conform to IPC-A-610 Class 2.

Assembly shall conform with RoHS Directive 2011/65/EU.

Components shall be placed according to the associated CPL and BOM documents.

Lead-free SAC305 solder shall be used.

Reflow profile shall comply with J-STD-20C Lead-Free Reflow Profile.

BGA components shall be 100% checked with x-ray for solder bridges after reflow.

Finished assemblies shall be removed from panel prior to delivery.

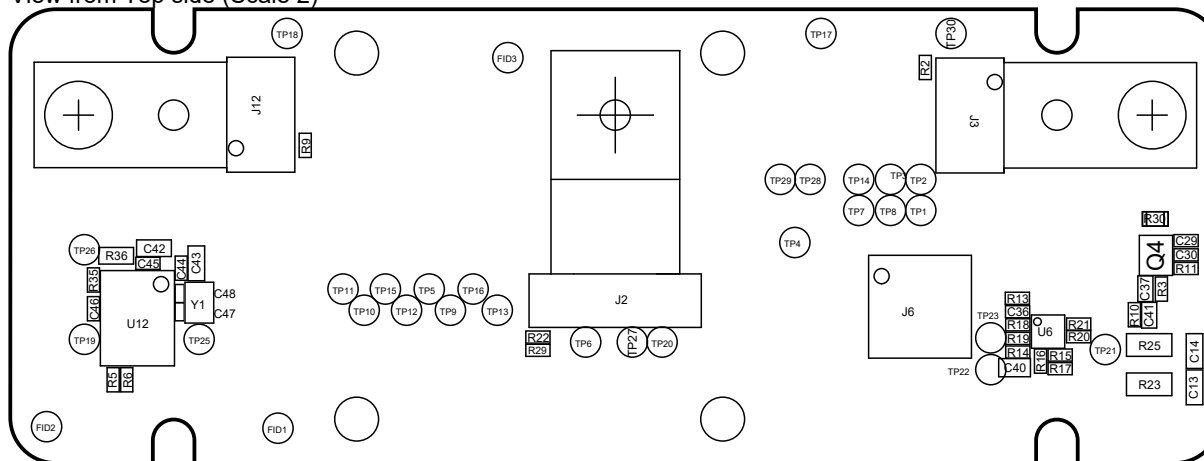
Notes:


1 Note 1

2 Note 2

3 Note 3

View from Top side (Scale 2)



Title: <b>DM1098LUX-D-LITE</b>		
Number: DXXXX	Revision: R1M0 E1	
Date: 07/06/2021	Sheet: 1 of 2	PROPRIETARY AND CONFIDENTIAL
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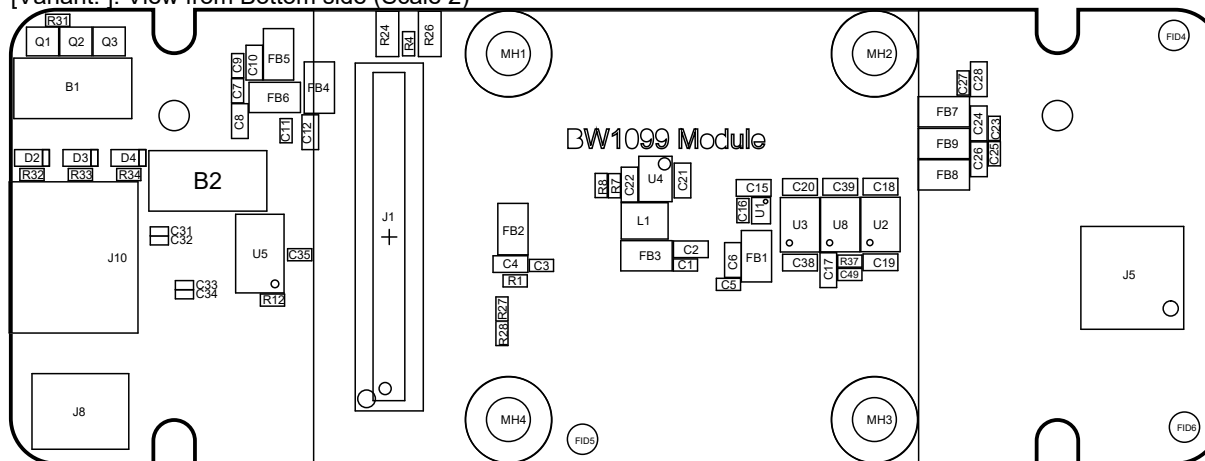
B

C

D

E

[Variant: ]: View from Bottom side (Scale 2)



Title: **DM1098LUX-D-LITE**

Number: DXXXX

Revision: R1M0  
E1

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Sheet: 2 of 2

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